

INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99)	Application Number		10829637	
	Filing Date		2004-04-22	
	First Named Inventor	Bednasz		
	Art Unit	2617		
	Examiner Name	Cumming		
Attorney Docket Number		2002-060		

U.S. PATENTS						Remove
Examiner Initial*	Cite No	Patent Number	Kind Code ¹	Issue Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
	1	7024176	B2	2006-04-04	Shimizu et al	corresponds to JPA2003179683 cited herein
	2	7139566	B2	2006-11-21	Ko et al.	corresponds to JPA2004104804 cited herein
If you wish to add additional U.S. Patent citation information please click the Add button.						Add

U.S. PATENT APPLICATION PUBLICATIONS						Remove
Examiner Initial*	Cite No	Publication Number	Kind Code ¹	Publication Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
	1					
If you wish to add additional U.S. Published Application citation information please click the Add button.						Add

FOREIGN PATENT DOCUMENTS							Remove	
Examiner Initial*	Cite No	Foreign Document Number ³	Country Code ² i	Kind Code ⁴	Publication Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear	Ts
	1	2003087400	JP	A	2003-03-20	NTT Docomo Inc		<input type="checkbox"/>
	2	2003179683	JP	A	2003-06-27	Hitachi Ltd		<input type="checkbox"/>

**INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**
(Not for submission under 37 CFR 1.99)

Application Number	10829637
Filing Date	2004-04-22
First Named Inventor	Bednasz
Art Unit	2617
Examiner Name	Cumming
Attorney Docket Number	2002-060

3	2004106801	JP	A	2004-04-08	Toshiba Corp		<input type="checkbox"/>
4	2001268490	JP	A	2001-09-28	Hewlett Packard Co <HP>		<input type="checkbox"/>
5	1128284	EP	A2	2001-08-29	Hewlett-Packard Company	corresponds to JPA2001268490 cited herein	<input type="checkbox"/>
6	2004104804	JP	A	2004-04-02	Samsung Electronics		<input type="checkbox"/>

If you wish to add additional Foreign Patent Document citation information please click the Add button [Add](#)

NON-PATENT LITERATURE DOCUMENTS

[Remove](#)

Examiner Initials*	Cite No	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc), date, pages(s), volume-issue number(s), publisher, city and/or country where published.	T ⁵
	1		<input type="checkbox"/>

If you wish to add additional non-patent literature document citation information please click the Add button [Add](#)

EXAMINER SIGNATURE

Examiner Signature	Date Considered
--------------------	-----------------

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through a citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹ See Kind Codes of USPTO Patent Documents at www.USPTO.GOV or MPEP 901.04. ² Enter office that issued the document, by the two-letter code (WIPO Standard ST.3). ³ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁴ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁵ Applicant is to place a check mark here if English language translation is attached.